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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

| | |
|--------------------------------|---|
| Product Status | Obsolete |
| Number of LABs/CLBs | 5831 |
| Number of Logic Elements/Cells | 74637 |
| Total RAM Bits | 3170304 |
| Number of I/O | 348 |
| Number of Gates | - |
| Voltage - Supply | 1.14V ~ 1.26V |
| Mounting Type | Surface Mount |
| Operating Temperature | -40°C ~ 100°C (TJ) |
| Package / Case | 676-BGA |
| Supplier Device Package | 676-FBGA (27x27) |
| Purchase URL | https://www.e-xfl.com/product-detail/xilinx/xc6slx75t-n3fgg676i |

Table 8: Recommended Operating Conditions for User I/Os Using Differential Signal Standards

| I/O Standard | V _{CCO} for Drivers | | |
|--------------------------|------------------------------|--------|--------|
| | V, Min | V, Nom | V, Max |
| LVDS_33 | 3.0 | 3.3 | 3.45 |
| LVDS_25 | 2.25 | 2.5 | 2.75 |
| BLVDS_25 | 2.25 | 2.5 | 2.75 |
| MINI_LVDS_33 | 3.0 | 3.3 | 3.45 |
| MINI_LVDS_25 | 2.25 | 2.5 | 2.75 |
| LVPECL_33 ⁽¹⁾ | N/A—Inputs Only | | |
| LVPECL_25 | N/A—Inputs Only | | |
| RSDS_33 | 3.0 | 3.3 | 3.45 |
| RSDS_25 | 2.25 | 2.5 | 2.75 |
| TMDS_33 ⁽¹⁾ | 3.14 | 3.3 | 3.45 |
| PPDS_33 | 3.0 | 3.3 | 3.45 |
| PPDS_25 | 2.25 | 2.5 | 2.75 |
| DISPLAY_PORT | 2.3 | 2.5 | 2.7 |
| DIFF_MOBILE_DDR | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_I | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_II | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_III | 1.4 | 1.5 | 1.6 |
| DIFF_HSTL_I_18 | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_II_18 | 1.7 | 1.8 | 1.9 |
| DIFF_HSTL_III_18 | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL3_I | 3.0 | 3.3 | 3.45 |
| DIFF_SSTL3_II | 3.0 | 3.3 | 3.45 |
| DIFF_SSTL2_I | 2.3 | 2.5 | 2.7 |
| DIFF_SSTL2_II | 2.3 | 2.5 | 2.7 |
| DIFF_SSTL18_I | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL18_II | 1.7 | 1.8 | 1.9 |
| DIFF_SSTL15_II | 1.425 | 1.5 | 1.575 |

Notes:

1. LVPECL_33 and TMDS_33 inputs require V_{CCAUX} = 3.3V nominal.

In **Table 9** and **Table 10**, values for V_{IL} and V_{IH} are recommended input voltages. Values for I_{OL} and I_{OH} are guaranteed over the recommended operating conditions at the V_{OL} and V_{OH} test points. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at a minimum V_{CCO} with the respective V_{OL} and V_{OH} voltage levels shown. Other standards are sample tested.

Table 9: Single-Ended I/O Standard DC Input and Output Levels

| I/O Standard | V_{IL} | | V_{IH} | | V_{OL} | V_{OH} | I_{OL} | I_{OH} |
|----------------|-----------|-------------------|-------------------|-----------------|-----------------|------------------|------------------------|------------------------|
| | V , Min | V , Max | V , Min | V , Max | V , Max | V , Min | mA | mA |
| LVTTL | -0.5 | 0.8 | 2.0 | 4.1 | 0.4 | 2.4 | Note 2 | Note 2 |
| LVCMOS33 | -0.5 | 0.8 | 2.0 | 4.1 | 0.4 | $V_{CCO} - 0.4$ | Note 2 | Note 2 |
| LVCMOS25 | -0.5 | 0.7 | 1.7 | 4.1 | 0.4 | $V_{CCO} - 0.4$ | Note 2 | Note 2 |
| LVCMOS18 | -0.5 | 0.38 | 0.8 | 4.1 | 0.45 | $V_{CCO} - 0.45$ | Note 2 | Note 2 |
| LVCMOS18 (-1L) | -0.5 | 0.33 | 0.71 | 4.1 | 0.45 | $V_{CCO} - 0.45$ | Note 2 | Note 2 |
| LVCMOS18_JEDEC | -0.5 | 35% V_{CCO} | 65% V_{CCO} | 4.1 | 0.45 | $V_{CCO} - 0.45$ | Note 2 | Note 2 |
| LVCMOS15 | -0.5 | 0.38 | 0.8 | 4.1 | 25% V_{CCO} | 75% V_{CCO} | Note 3 | Note 3 |
| LVCMOS15 (-1L) | -0.5 | 0.33 | 0.71 | 4.1 | 25% V_{CCO} | 75% V_{CCO} | Note 3 | Note 3 |
| LVCMOS15_JEDEC | -0.5 | 35% V_{CCO} | 65% V_{CCO} | 4.1 | 25% V_{CCO} | 75% V_{CCO} | Note 3 | Note 3 |
| LVCMOS12 | -0.5 | 0.38 | 0.8 | 4.1 | 0.4 | $V_{CCO} - 0.4$ | Note 4 | Note 4 |
| LVCMOS12 (-1L) | -0.5 | 0.33 | 0.71 | 4.1 | 0.4 | $V_{CCO} - 0.4$ | Note 4 | Note 4 |
| LVCMOS12_JEDEC | -0.5 | 35% V_{CCO} | 65% V_{CCO} | 4.1 | 0.4 | $V_{CCO} - 0.4$ | Note 4 | Note 4 |
| PCI33_3 | -0.5 | 30% V_{CCO} | 50% V_{CCO} | $V_{CCO} + 0.5$ | 10% V_{CCO} | 90% V_{CCO} | 1.5 | -0.5 |
| PCI66_3 | -0.5 | 30% V_{CCO} | 50% V_{CCO} | $V_{CCO} + 0.5$ | 10% V_{CCO} | 90% V_{CCO} | 1.5 | -0.5 |
| I2C | -0.5 | 25% V_{CCO} | 70% V_{CCO} | 4.1 | 20% V_{CCO} | - | 3 | - |
| SMBUS | -0.5 | 0.8 | 2.1 | 4.1 | 0.4 | - | 4 | - |
| SDIO | -0.5 | 12.5% V_{CCO} | 75% V_{CCO} | 4.1 | 12.5% V_{CCO} | 75% V_{CCO} | 0.1 | -0.1 |
| MOBILE_DDR | -0.5 | 20% V_{CCO} | 80% V_{CCO} | 4.1 | 10% V_{CCO} | 90% V_{CCO} | 0.1 | -0.1 |
| HSTL_I | -0.5 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 4.1 | 0.4 | $V_{CCO} - 0.4$ | 8 | -8 |
| HSTL_II | -0.5 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 4.1 | 0.4 | $V_{CCO} - 0.4$ | 16 | -16 |
| HSTL_III | -0.5 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 4.1 | 0.4 | $V_{CCO} - 0.4$ | 24 | -8 |
| HSTL_I_18 | -0.5 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 4.1 | 0.4 | $V_{CCO} - 0.4$ | 11 | -11 |
| HSTL_II_18 | -0.5 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 4.1 | 0.4 | $V_{CCO} - 0.4$ | 22 | -22 |
| HSTL_III_18 | -0.5 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 4.1 | 0.4 | $V_{CCO} - 0.4$ | 30 | -11 |
| SSTL3_I | -0.5 | $V_{REF} - 0.2$ | $V_{REF} + 0.2$ | 4.1 | $V_{TT} - 0.6$ | $V_{TT} + 0.6$ | 8 | -8 |
| SSTL3_II | -0.5 | $V_{REF} - 0.2$ | $V_{REF} + 0.2$ | 4.1 | $V_{TT} - 0.8$ | $V_{TT} + 0.8$ | 16 | -16 |
| SSTL2_I | -0.5 | $V_{REF} - 0.15$ | $V_{REF} + 0.15$ | 4.1 | $V_{TT} - 0.61$ | $V_{TT} + 0.61$ | 8.1 | -8.1 |
| SSTL2_II | -0.5 | $V_{REF} - 0.15$ | $V_{REF} + 0.15$ | 4.1 | $V_{TT} - 0.81$ | $V_{TT} + 0.81$ | 16.2 | -16.2 |
| SSTL18_I | -0.5 | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | 4.1 | $V_{TT} - 0.47$ | $V_{TT} + 0.47$ | 6.7 | -6.7 |
| SSTL18_II | -0.5 | $V_{REF} - 0.125$ | $V_{REF} + 0.125$ | 4.1 | $V_{TT} - 0.60$ | $V_{TT} + 0.60$ | 13.4 | -13.4 |
| SSTL15_II | -0.5 | $V_{REF} - 0.1$ | $V_{REF} + 0.1$ | 4.1 | $V_{TT} - 0.4$ | $V_{TT} + 0.4$ | 13.4 | -13.4 |

Notes:

- Tested according to relevant specifications.
- Using drive strengths of 2, 4, 6, 8, 12, 16, or 24 mA.
- Using drive strengths of 2, 4, 6, 8, 12, or 16 mA.
- Using drive strengths of 2, 4, 6, 8, or 12 mA.
- For more information, refer to [UG381: Spartan-6 FPGA SelectIO Resources User Guide](#).

GTP Transceiver DC Input and Output Levels

Table 16 summarizes the DC output specifications of the GTP transceivers in Spartan-6 FPGAs. Figure 1 shows the single-ended output voltage swing. Figure 2 shows the peak-to-peak differential output voltage.

Consult [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#) for further details.

Table 16: GTP Transceiver DC Specifications

| Symbol | DC Parameter | Conditions | Min | Typ | Max | Units |
|----------------------|---|--|----------------------------------|------------------|-----------|-------|
| DV _{PPIN} | Differential peak-to-peak input voltage | External AC coupled | 140 | — | 2000 | mV |
| V _{IN} | Absolute input voltage | DC coupled MGTAVTTRX = 1.2V | -400 | — | MGTAVTTRX | mV |
| V _{CMIN} | Common mode input voltage | DC coupled MGTAVTTRX = 1.2V | — | 3/4 MGTAVTTRX | — | mV |
| DV _{PPOUT} | Differential peak-to-peak output voltage ⁽¹⁾ | Transmitter output swing is set to maximum setting | — | — | 1000 | mV |
| V _{SEOUT} | Single-ended output voltage ⁽¹⁾ | — | — | — | 500 | mV |
| V _{CMOUTDC} | Common mode output voltage | Equation based | MGTAVTTX - V _{SEOUT} /2 | | | mV |
| R _{IN} | Differential input resistance | — | 80 | 100 | 130 | Ω |
| R _{OUT} | Differential output resistance | — | 80 | 100 | 130 | Ω |
| T _{OSKEW} | Transmitter output skew | — | — | — | 15 | ps |
| C _{EXT} | Recommended external AC coupling capacitor ⁽²⁾ | — | 75 | 100 | 200 | nF |

Notes:

1. The output swing and preemphasis levels are programmable using the attributes discussed in [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#) and can result in values lower than reported in this table.
2. Other values can be used as appropriate to conform to specific protocols and standards.

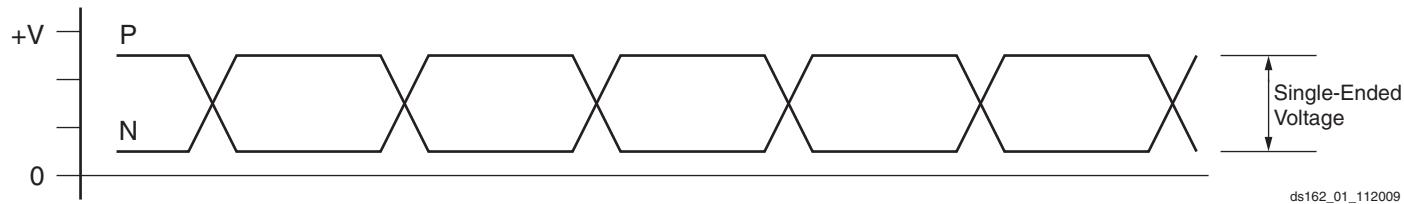


Figure 1: Single-Ended Peak-to-Peak Voltage

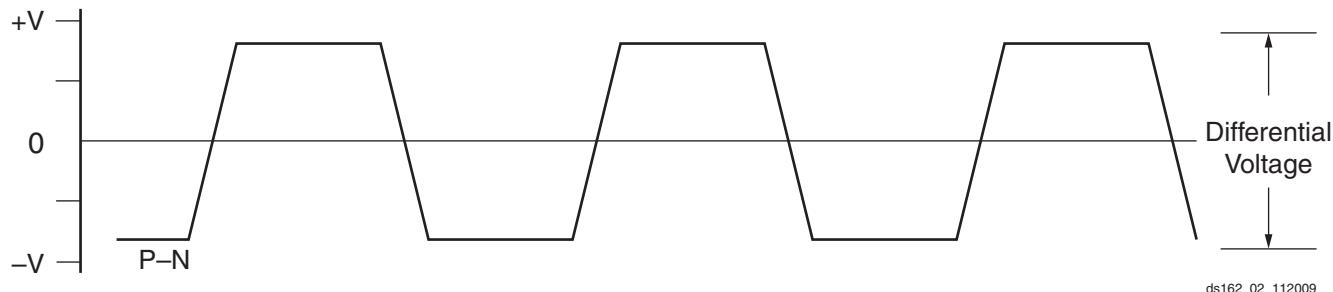


Figure 2: Differential Peak-to-Peak Voltage

Table 17 summarizes the DC specifications of the clock input of the GTP transceiver. Consult [UG386: Spartan-6 FPGA GTP Transceivers User Guide](#) for further details.

Table 23: GTP Transceiver Receiver Switching Characteristics

| Symbol | Description | | | Min | Typ | Max | Units | |
|---|---|--|----------------------|-------|------|------|-------|--|
| T _{RXELECIDLE} | Time for RXELECIDLE to respond to loss or restoration of data | | | — | 75 | — | ns | |
| R _{XOOBVDPP} | OOB detect threshold peak-to-peak | | | 60 | — | 150 | mV | |
| R _{XSST} | Receiver spread-spectrum tracking ⁽¹⁾ | | | -5000 | — | 0 | ppm | |
| R _{XRXL} | Run length (CID) | Internal AC capacitor bypassed | | | — | 150 | UI | |
| R _{XPPMTOL} | Data/REFCLK PPM offset tolerance | CDR 2 nd -order loop disabled | | | -200 | — | 200 | |
| | | CDR 2 nd -order loop enabled | PLL_RXDIVSEL_OUT = 1 | -2000 | — | 2000 | ppm | |
| | | | PLL_RXDIVSEL_OUT = 2 | -2000 | — | 2000 | ppm | |
| | | | PLL_RXDIVSEL_OUT = 4 | -1000 | — | 1000 | ppm | |
| SJ Jitter Tolerance⁽²⁾ | | | | | | | | |
| JT_SJ _{3.125} | Sinusoidal Jitter ⁽³⁾ | | 3.125 Gb/s | 0.4 | — | — | UI | |
| JT_SJ _{2.5} | Sinusoidal Jitter ⁽³⁾ | | 2.5 Gb/s | 0.4 | — | — | UI | |
| JT_SJ _{1.62} | Sinusoidal Jitter ⁽³⁾ | | 1.62 Gb/s | 0.5 | — | — | UI | |
| JT_SJ _{1.25} | Sinusoidal Jitter ⁽³⁾ | | 1.25 Gb/s | 0.5 | — | — | UI | |
| JT_SJ ₆₁₄ | Sinusoidal Jitter ⁽³⁾ | | 614 Mb/s | 0.5 | — | — | UI | |
| SJ Jitter Tolerance with Stressed Eye⁽²⁾⁽⁵⁾ | | | | | | | | |
| JT_TJSE _{3.125} | Total Jitter with stressed eye ⁽⁴⁾ | 3.125 Gb/s | 0.65 | — | — | — | UI | |
| JT_SJSE _{3.125} | Sinusoidal Jitter with stressed eye | 3.125 Gb/s | 0.1 | — | — | — | UI | |
| JT_TJSE _{2.7} | Total Jitter with stressed eye ⁽⁴⁾ | 2.7 Gb/s | 0.65 | — | — | — | UI | |
| JT_SJSE _{2.7} | Sinusoidal Jitter with stressed eye | 2.7 Gb/s | 0.1 | — | — | — | UI | |

Notes:

1. Using PLL_RXDIVSEL_OUT = 1, 2, and 4.
2. All jitter values are based on a Bit Error Ratio of $1e^{-12}$.
3. Using 80 MHz sinusoidal jitter only in the absence of deterministic and random jitter.
4. Composed of 0.37 UI DJ in the form of ISI and 0.18 UI RJ.
5. Measured using PRBS7 data pattern.

Endpoint Block for PCI Express Designs Switching Characteristics

The Endpoint block for PCI Express is available in the Spartan-6 LXT devices. Consult the [Spartan-6 FPGA Integrated Endpoint Block for PCI Express](#) for further information.

Table 24: Maximum Performance for PCI Express Designs

| Symbol | Description | Speed Grade | | | | Units |
|-----------------------|------------------------------|-------------|------|------|-----|-------|
| | | -3 | -3N | -2 | -1L | |
| F _{PCIEUSER} | User clock maximum frequency | 62.5 | 62.5 | 62.5 | N/A | MHz |

Performance Characteristics

This section provides the performance characteristics of some common functions and designs implemented in Spartan-6 devices. The numbers reported here are worst-case values; they have all been fully characterized. These values are subject to the same guidelines as the [Switching Characteristics, page 19](#).

Table 25: Interface Performances

| Description | I/O Resource | Clock Buffer | Data Width | Speed Grade | | | | Units | | |
|---|--------------------------|---------------------|-------------------|--------------------|------------------------|-----------|------------|--------------|--|--|
| | | | | -3 | -3N | -2 | -1L | | | |
| Networking Applications⁽¹⁾ | | | | | | | | | | |
| SDR LVDS transmitter or receiver | IOB SDR register | BUFG | — | 400 | 400 | 375 | 250 | Mb/s | | |
| DDR LVDS transmitter or receiver | ODDR2/IDDR2 register | 2 BUFGs | — | 800 | 800 | 750 | 500 | Mb/s | | |
| SDR LVDS transmitter | OSERDES2 | BUFPLL | 2 | 500 | 500 | 500 | 250 | Mb/s | | |
| | | | 3 | 750 | 750 | 750 | 375 | Mb/s | | |
| | | | 4-8 | 1080 | 1050 | 950 | 500 | Mb/s | | |
| DDR LVDS transmitter | OSERDES2 | 2 BUFIO2s | 2 | 500 | 500 | 500 | 250 | Mb/s | | |
| | | | 3 | 750 | 750 | 750 | 375 | Mb/s | | |
| | | | 4-8 | 1080 | 1050 | 950 | 500 | Mb/s | | |
| SDR LVDS receiver | ISERDES2 in RETIMED mode | BUFPLL | 2 | 500 | 500 | 500 | — | Mb/s | | |
| | | | 3 | 750 | 750 | 750 | — | Mb/s | | |
| | | | 4-8 | 1080 | 1050 | 950 | — | Mb/s | | |
| DDR LVDS receiver | ISERDES2 in RETIMED mode | 2 BUFIO2s | 2 | 500 | 500 | 500 | — | Mb/s | | |
| | | | 3 | 750 | 750 | 750 | — | Mb/s | | |
| | | | 4-8 | 1080 | 1050 | 950 | — | Mb/s | | |
| Memory Interfaces (Implemented using the Spartan-6 FPGA Memory Controller Block)⁽²⁾ | | | | | | | | | | |
| Standard Performance (Standard V_{CCINT}) | | | | | | | | | | |
| DDR | | | | 400 | Note 4 | 400 | 350 | Mb/s | | |
| DDR2 | | | | 667 | Note 4 | 625 | 400 | Mb/s | | |
| DDR3 | | | | 800 | Note 4 | 667 | — | Mb/s | | |
| LPDDR (Mobile_DDR) | | | | 400 | Note 4 | 400 | 350 | Mb/s | | |
| Extended Performance (Requires Extended Performance V_{CCINT})⁽³⁾ | | | | | | | | | | |
| DDR2 | | | | 800 | Note 4 | 667 | — | Mb/s | | |

Notes:

- Refer to [XAPP1064](#), *Source-Synchronous Serialization and Deserialization (up to 1050 Mb/s)* and [UG381](#), *Spartan-6 FPGA SelectIO Resources User Guide*.
- Refer to [UG388](#), *Spartan-6 FPGA Memory Controller User Guide*.
- Extended Memory Controller block performance for DDR2 can be achieved using the extended performance V_{CCINT} range from [Table 2](#).
- The LX4 device, all devices in the TQG144 and CPG196 packages, and the -3N speed grade do not support a Memory Controller Block.

Table 28: IOB Switching Characteristics for the Commercial (XC) Spartan-6 Devices (Cont'd)

| I/O Standard | T _{IOPI} | | | | T _{IOOP} | | | | T _{IOTP} | | | | Units | |
|--------------------------|-------------------|------|------|--------------------|-------------------|------|------|--------------------|-------------------|------|------|--------------------|-------|--|
| | Speed Grade | | | | Speed Grade | | | | Speed Grade | | | | | |
| | -3 | -3N | -2 | -1L ⁽¹⁾ | -3 | -3N | -2 | -1L ⁽¹⁾ | -3 | -3N | -2 | -1L ⁽¹⁾ | | |
| LVCMOS33, Fast, 8 mA | 1.34 | 1.46 | 1.59 | 1.82 | 2.07 | 2.21 | 2.41 | 3.03 | 2.07 | 2.21 | 2.41 | 3.03 | ns | |
| LVCMOS33, Fast, 12 mA | 1.34 | 1.46 | 1.59 | 1.82 | 1.65 | 1.79 | 1.99 | 2.62 | 1.65 | 1.79 | 1.99 | 2.62 | ns | |
| LVCMOS33, Fast, 16 mA | 1.34 | 1.46 | 1.59 | 1.82 | 1.65 | 1.79 | 1.99 | 2.62 | 1.65 | 1.79 | 1.99 | 2.62 | ns | |
| LVCMOS33, Fast, 24 mA | 1.34 | 1.46 | 1.59 | 1.82 | 1.65 | 1.79 | 1.99 | 2.62 | 1.65 | 1.79 | 1.99 | 2.62 | ns | |
| LVCMOS25, QUIETIO, 2 mA | 0.82 | 0.94 | 1.07 | 1.31 | 4.81 | 4.95 | 5.15 | 5.79 | 4.81 | 4.95 | 5.15 | 5.79 | ns | |
| LVCMOS25, QUIETIO, 4 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.70 | 3.84 | 4.04 | 4.66 | 3.70 | 3.84 | 4.04 | 4.66 | ns | |
| LVCMOS25, QUIETIO, 6 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.46 | 3.60 | 3.80 | 4.38 | 3.46 | 3.60 | 3.80 | 4.38 | ns | |
| LVCMOS25, QUIETIO, 8 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.20 | 3.34 | 3.54 | 4.12 | 3.20 | 3.34 | 3.54 | 4.12 | ns | |
| LVCMOS25, QUIETIO, 12 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.83 | 2.97 | 3.17 | 3.75 | 2.83 | 2.97 | 3.17 | 3.75 | ns | |
| LVCMOS25, QUIETIO, 16 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.64 | 2.78 | 2.98 | 3.64 | 2.64 | 2.78 | 2.98 | 3.64 | ns | |
| LVCMOS25, QUIETIO, 24 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.45 | 2.59 | 2.79 | 3.42 | 2.45 | 2.59 | 2.79 | 3.42 | ns | |
| LVCMOS25, Slow, 2 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.78 | 3.92 | 4.12 | 4.76 | 3.78 | 3.92 | 4.12 | 4.76 | ns | |
| LVCMOS25, Slow, 4 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.79 | 2.93 | 3.13 | 3.73 | 2.79 | 2.93 | 3.13 | 3.73 | ns | |
| LVCMOS25, Slow, 6 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.73 | 2.87 | 3.07 | 3.66 | 2.73 | 2.87 | 3.07 | 3.66 | ns | |
| LVCMOS25, Slow, 8 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.48 | 2.62 | 2.82 | 3.42 | 2.48 | 2.62 | 2.82 | 3.42 | ns | |
| LVCMOS25, Slow, 12 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.01 | 2.15 | 2.35 | 2.95 | 2.01 | 2.15 | 2.35 | 2.95 | ns | |
| LVCMOS25, Slow, 16 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.01 | 2.15 | 2.35 | 2.95 | 2.01 | 2.15 | 2.35 | 2.95 | ns | |
| LVCMOS25, Slow, 24 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.01 | 2.15 | 2.35 | 2.94 | 2.01 | 2.15 | 2.35 | 2.94 | ns | |
| LVCMOS25, Fast, 2 mA | 0.82 | 0.94 | 1.07 | 1.31 | 3.35 | 3.49 | 3.69 | 4.31 | 3.35 | 3.49 | 3.69 | 4.31 | ns | |
| LVCMOS25, Fast, 4 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.25 | 2.39 | 2.59 | 3.22 | 2.25 | 2.39 | 2.59 | 3.22 | ns | |
| LVCMOS25, Fast, 6 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.09 | 2.23 | 2.43 | 3.05 | 2.09 | 2.23 | 2.43 | 3.05 | ns | |
| LVCMOS25, Fast, 8 mA | 0.82 | 0.94 | 1.07 | 1.31 | 2.02 | 2.16 | 2.36 | 2.98 | 2.02 | 2.16 | 2.36 | 2.98 | ns | |
| LVCMOS25, Fast, 12 mA | 0.82 | 0.94 | 1.07 | 1.31 | 1.56 | 1.70 | 1.90 | 2.52 | 1.56 | 1.70 | 1.90 | 2.52 | ns | |
| LVCMOS25, Fast, 16 mA | 0.82 | 0.94 | 1.07 | 1.31 | 1.56 | 1.70 | 1.90 | 2.52 | 1.56 | 1.70 | 1.90 | 2.52 | ns | |
| LVCMOS25, Fast, 24 mA | 0.82 | 0.94 | 1.07 | 1.31 | 1.56 | 1.70 | 1.90 | 2.52 | 1.56 | 1.70 | 1.90 | 2.52 | ns | |
| LVCMOS18, QUIETIO, 2 mA | 1.18 | 1.30 | 1.43 | 2.04 | 5.92 | 6.06 | 6.26 | 6.80 | 5.92 | 6.06 | 6.26 | 6.80 | ns | |
| LVCMOS18, QUIETIO, 4 mA | 1.18 | 1.30 | 1.43 | 2.04 | 4.74 | 4.88 | 5.08 | 5.63 | 4.74 | 4.88 | 5.08 | 5.63 | ns | |
| LVCMOS18, QUIETIO, 6 mA | 1.18 | 1.30 | 1.43 | 2.04 | 4.05 | 4.19 | 4.39 | 4.96 | 4.05 | 4.19 | 4.39 | 4.96 | ns | |
| LVCMOS18, QUIETIO, 8 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.71 | 3.85 | 4.05 | 4.63 | 3.71 | 3.85 | 4.05 | 4.63 | ns | |
| LVCMOS18, QUIETIO, 12 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.35 | 3.49 | 3.69 | 4.27 | 3.35 | 3.49 | 3.69 | 4.27 | ns | |
| LVCMOS18, QUIETIO, 16 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.20 | 3.34 | 3.54 | 4.14 | 3.20 | 3.34 | 3.54 | 4.14 | ns | |
| LVCMOS18, QUIETIO, 24 mA | 1.18 | 1.30 | 1.43 | 2.04 | 2.96 | 3.10 | 3.30 | 3.98 | 2.96 | 3.10 | 3.30 | 3.98 | ns | |
| LVCMOS18, Slow, 2 mA | 1.18 | 1.30 | 1.43 | 2.04 | 4.62 | 4.76 | 4.96 | 5.54 | 4.62 | 4.76 | 4.96 | 5.54 | ns | |
| LVCMOS18, Slow, 4 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.69 | 3.83 | 4.03 | 4.60 | 3.69 | 3.83 | 4.03 | 4.60 | ns | |
| LVCMOS18, Slow, 6 mA | 1.18 | 1.30 | 1.43 | 2.04 | 3.00 | 3.14 | 3.34 | 3.94 | 3.00 | 3.14 | 3.34 | 3.94 | ns | |
| LVCMOS18, Slow, 8 mA | 1.18 | 1.30 | 1.43 | 2.04 | 2.19 | 2.33 | 2.53 | 3.17 | 2.19 | 2.33 | 2.53 | 3.17 | ns | |
| LVCMOS18, Slow, 12 mA | 1.18 | 1.30 | 1.43 | 2.04 | 1.99 | 2.13 | 2.33 | 2.95 | 1.99 | 2.13 | 2.33 | 2.95 | ns | |
| LVCMOS18, Slow, 16 mA | 1.18 | 1.30 | 1.43 | 2.04 | 1.99 | 2.13 | 2.33 | 2.95 | 1.99 | 2.13 | 2.33 | 2.95 | ns | |

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

| I/O Standard | T _{IOP1} | | T _{IOOP} | | T _{IOTP} | | Units | |
|--------------------------|-------------------|------|-------------------|------|-------------------|------|-------|--|
| | Speed Grade | | Speed Grade | | Speed Grade | | | |
| | -3 | -2 | -3 | -2 | -3 | -2 | | |
| DIFF_SSTL3_I | 1.26 | 1.44 | 1.95 | 2.15 | 1.95 | 2.15 | ns | |
| DIFF_SSTL3_II | 1.26 | 1.44 | 1.94 | 2.14 | 1.94 | 2.14 | ns | |
| DIFF_SSTL2_I | 1.09 | 1.27 | 1.94 | 2.14 | 1.94 | 2.14 | ns | |
| DIFF_SSTL2_II | 1.09 | 1.27 | 1.90 | 2.10 | 1.90 | 2.10 | ns | |
| DIFF_SSTL18_I | 1.04 | 1.22 | 1.86 | 2.06 | 1.86 | 2.06 | ns | |
| DIFF_SSTL18_II | 1.05 | 1.23 | 1.82 | 2.02 | 1.82 | 2.02 | ns | |
| DIFF_SSTL15_II | 1.01 | 1.19 | 1.81 | 2.01 | 1.81 | 2.01 | ns | |
| DIFF_MOBILE_DDR | 1.04 | 1.22 | 1.89 | 2.09 | 1.89 | 2.09 | ns | |
| LVTTL, QUIETIO, 2 mA | 1.42 | 1.60 | 5.64 | 5.84 | 5.64 | 5.84 | ns | |
| LVTTL, QUIETIO, 4 mA | 1.42 | 1.60 | 4.46 | 4.66 | 4.46 | 4.66 | ns | |
| LVTTL, QUIETIO, 6 mA | 1.42 | 1.60 | 3.92 | 4.12 | 3.92 | 4.12 | ns | |
| LVTTL, QUIETIO, 8 mA | 1.42 | 1.60 | 3.37 | 3.57 | 3.37 | 3.57 | ns | |
| LVTTL, QUIETIO, 12 mA | 1.42 | 1.60 | 3.42 | 3.62 | 3.42 | 3.62 | ns | |
| LVTTL, QUIETIO, 16 mA | 1.42 | 1.60 | 3.09 | 3.29 | 3.09 | 3.29 | ns | |
| LVTTL, QUIETIO, 24 mA | 1.42 | 1.60 | 2.83 | 3.03 | 2.83 | 3.03 | ns | |
| LVTTL, Slow, 2 mA | 1.42 | 1.60 | 4.58 | 4.78 | 4.58 | 4.78 | ns | |
| LVTTL, Slow, 4 mA | 1.42 | 1.60 | 3.38 | 3.58 | 3.38 | 3.58 | ns | |
| LVTTL, Slow, 6 mA | 1.42 | 1.60 | 2.95 | 3.15 | 2.95 | 3.15 | ns | |
| LVTTL, Slow, 8 mA | 1.42 | 1.60 | 2.73 | 2.93 | 2.73 | 2.93 | ns | |
| LVTTL, Slow, 12 mA | 1.42 | 1.60 | 2.72 | 2.92 | 2.72 | 2.92 | ns | |
| LVTTL, Slow, 16 mA | 1.42 | 1.60 | 2.53 | 2.73 | 2.53 | 2.73 | ns | |
| LVTTL, Slow, 24 mA | 1.42 | 1.60 | 2.42 | 2.62 | 2.42 | 2.62 | ns | |
| LVTTL, Fast, 2 mA | 1.42 | 1.60 | 4.04 | 4.24 | 4.04 | 4.24 | ns | |
| LVTTL, Fast, 4 mA | 1.42 | 1.60 | 2.66 | 2.86 | 2.66 | 2.86 | ns | |
| LVTTL, Fast, 6 mA | 1.42 | 1.60 | 2.58 | 2.78 | 2.58 | 2.78 | ns | |
| LVTTL, Fast, 8 mA | 1.42 | 1.60 | 2.46 | 2.66 | 2.46 | 2.66 | ns | |
| LVTTL, Fast, 12 mA | 1.42 | 1.60 | 1.97 | 2.17 | 1.97 | 2.17 | ns | |
| LVTTL, Fast, 16 mA | 1.42 | 1.60 | 1.97 | 2.17 | 1.97 | 2.17 | ns | |
| LVTTL, Fast, 24 mA | 1.42 | 1.60 | 1.97 | 2.17 | 1.97 | 2.17 | ns | |
| LVCMOS33, QUIETIO, 2 mA | 1.41 | 1.59 | 5.65 | 5.85 | 5.65 | 5.85 | ns | |
| LVCMOS33, QUIETIO, 4 mA | 1.41 | 1.59 | 4.20 | 4.40 | 4.20 | 4.40 | ns | |
| LVCMOS33, QUIETIO, 6 mA | 1.41 | 1.59 | 3.65 | 3.85 | 3.65 | 3.85 | ns | |
| LVCMOS33, QUIETIO, 8 mA | 1.41 | 1.59 | 3.51 | 3.71 | 3.51 | 3.71 | ns | |
| LVCMOS33, QUIETIO, 12 mA | 1.41 | 1.59 | 3.09 | 3.29 | 3.09 | 3.29 | ns | |
| LVCMOS33, QUIETIO, 16 mA | 1.41 | 1.59 | 2.91 | 3.11 | 2.91 | 3.11 | ns | |
| LVCMOS33, QUIETIO, 24 mA | 1.41 | 1.59 | 2.73 | 2.93 | 2.73 | 2.93 | ns | |
| LVCMOS33, Slow, 2 mA | 1.41 | 1.59 | 4.59 | 4.79 | 4.59 | 4.79 | ns | |
| LVCMOS33, Slow, 4 mA | 1.41 | 1.59 | 3.14 | 3.34 | 3.14 | 3.34 | ns | |

Table 29: IOB Switching Characteristics for the Automotive XA Spartan-6 and the Spartan-6Q Devices⁽¹⁾ (Cont'd)

| I/O Standard | T_{IOPI} | | T_{IOOP} | | T_{IOTP} | | Units | |
|--------------------------------|-------------|------|-------------|------|-------------|------|-------|--|
| | Speed Grade | | Speed Grade | | Speed Grade | | | |
| | -3 | -2 | -3 | -2 | -3 | -2 | | |
| LVCMOS12, QUIETIO, 6 mA | 0.98 | 1.16 | 4.79 | 4.99 | 4.79 | 4.99 | ns | |
| LVCMOS12, QUIETIO, 8 mA | 0.98 | 1.16 | 4.43 | 4.63 | 4.43 | 4.63 | ns | |
| LVCMOS12, QUIETIO, 12 mA | 0.98 | 1.16 | 4.18 | 4.38 | 4.18 | 4.38 | ns | |
| LVCMOS12, Slow, 2 mA | 0.98 | 1.16 | 5.12 | 5.32 | 5.12 | 5.32 | ns | |
| LVCMOS12, Slow, 4 mA | 0.98 | 1.16 | 3.00 | 3.20 | 3.00 | 3.20 | ns | |
| LVCMOS12, Slow, 6 mA | 0.98 | 1.16 | 2.91 | 3.11 | 2.91 | 3.11 | ns | |
| LVCMOS12, Slow, 8 mA | 0.98 | 1.16 | 2.51 | 2.71 | 2.51 | 2.71 | ns | |
| LVCMOS12, Slow, 12 mA | 0.98 | 1.16 | 2.25 | 2.45 | 2.25 | 2.45 | ns | |
| LVCMOS12, Fast, 2 mA | 0.98 | 1.16 | 3.60 | 3.80 | 3.60 | 3.80 | ns | |
| LVCMOS12, Fast, 4 mA | 0.98 | 1.16 | 2.49 | 2.69 | 2.49 | 2.69 | ns | |
| LVCMOS12, Fast, 6 mA | 0.98 | 1.16 | 1.94 | 2.14 | 1.94 | 2.14 | ns | |
| LVCMOS12, Fast, 8 mA | 0.98 | 1.16 | 1.82 | 2.02 | 1.82 | 2.02 | ns | |
| LVCMOS12, Fast, 12 mA | 0.98 | 1.16 | 1.80 | 2.00 | 1.80 | 2.00 | ns | |
| LVCMOS12_JEDEC, QUIETIO, 2 mA | 1.57 | 1.75 | 6.53 | 6.73 | 6.53 | 6.73 | ns | |
| LVCMOS12_JEDEC, QUIETIO, 4 mA | 1.57 | 1.75 | 5.12 | 5.32 | 5.12 | 5.32 | ns | |
| LVCMOS12_JEDEC, QUIETIO, 6 mA | 1.57 | 1.75 | 4.81 | 5.01 | 4.81 | 5.01 | ns | |
| LVCMOS12_JEDEC, QUIETIO, 8 mA | 1.57 | 1.75 | 4.44 | 4.64 | 4.44 | 4.64 | ns | |
| LVCMOS12_JEDEC, QUIETIO, 12 mA | 1.57 | 1.75 | 4.20 | 4.40 | 4.20 | 4.40 | ns | |
| LVCMOS12_JEDEC, Slow, 2 mA | 1.57 | 1.75 | 5.14 | 5.34 | 5.14 | 5.34 | ns | |
| LVCMOS12_JEDEC, Slow, 4 mA | 1.57 | 1.75 | 2.99 | 3.19 | 2.99 | 3.19 | ns | |
| LVCMOS12_JEDEC, Slow, 6 mA | 1.57 | 1.75 | 2.90 | 3.10 | 2.90 | 3.10 | ns | |
| LVCMOS12_JEDEC, Slow, 8 mA | 1.57 | 1.75 | 2.50 | 2.70 | 2.50 | 2.70 | ns | |
| LVCMOS12_JEDEC, Slow, 12 mA | 1.57 | 1.75 | 2.26 | 2.46 | 2.26 | 2.46 | ns | |
| LVCMOS12_JEDEC, Fast, 2 mA | 1.57 | 1.75 | 3.60 | 3.80 | 3.60 | 3.80 | ns | |
| LVCMOS12_JEDEC, Fast, 4 mA | 1.57 | 1.75 | 2.49 | 2.69 | 2.49 | 2.69 | ns | |
| LVCMOS12_JEDEC, Fast, 6 mA | 1.57 | 1.75 | 1.94 | 2.14 | 1.94 | 2.14 | ns | |
| LVCMOS12_JEDEC, Fast, 8 mA | 1.57 | 1.75 | 1.83 | 2.03 | 1.83 | 2.03 | ns | |
| LVCMOS12_JEDEC, Fast, 12 mA | 1.57 | 1.75 | 1.80 | 2.00 | 1.80 | 2.00 | ns | |

Notes:

1. The Spartan-6Q FPGA -1L values are listed in Table 28.

Table 30 summarizes the value of T_{IOTPHZ} . T_{IOTPHZ} is described as the delay from the T pin to the IOB pad through the output buffer of an IOB pad, when 3-state is enabled (i.e., a high impedance state). These delays are measured using LVCMOS25, Fast, 12 mA.

Table 30: IOB 3-state ON Output Switching Characteristics (T_{IOTPHZ})

| Symbol | Description | Speed Grade | | | | Units |
|--------------|-------------------------------|-------------|------|------|------|-------|
| | | -3 | -3N | -2 | -1L | |
| T_{IOTPHZ} | T input to Pad high-impedance | 1.39 | 1.59 | 1.59 | 1.91 | ns |

I/O Standard Measurement Methodology

Input Delay Measurements

Table 31 shows the test setup parameters used for measuring input delay.

Table 31: Input Delay Measurement Methodology

| Description | I/O Standard Attribute | $V_L^{(1)}$ | $V_H^{(1)}$ | $V_{MEAS}^{(3)(4)}$ | $V_{REF}^{(2)(4)}$ |
|--|----------------------------|-----------------------|------------------|---------------------|--------------------|
| LVTTL (Low-Voltage Transistor-Transistor Logic) | LVTTL | 0 | 3.0 | 1.4 | — |
| LVCMOS (Low-Voltage CMOS), 3.3V | LVCMOS33 | 0 | 3.3 | 1.65 | — |
| LVCMOS, 2.5V | LVCMOS25 | 0 | 2.5 | 1.25 | — |
| LVCMOS, 1.8V | LVCMOS18 | 0 | 1.8 | 0.9 | — |
| LVCMOS, 1.5V | LVCMOS15 | 0 | 1.5 | 0.75 | — |
| LVCMOS, 1.2V | LVCMOS12 | 0 | 1.2 | 0.6 | — |
| PCI (Peripheral Component Interface), 33 MHz and 66 MHz, 3.3V | PCI33_3, PCI66_3 | Per PCI Specification | | | — |
| HSTL (High-Speed Transceiver Logic), Class I & II | HSTL_I, HSTL_II | $V_{REF} - 0.5$ | $V_{REF} + 0.5$ | V_{REF} | 0.75 |
| HSTL, Class III | HSTL_III | $V_{REF} - 0.5$ | $V_{REF} + 0.5$ | V_{REF} | 0.90 |
| HSTL, Class I & II, 1.8V | HSTL_I_18, HSTL_II_18 | $V_{REF} - 0.5$ | $V_{REF} + 0.5$ | V_{REF} | 0.90 |
| HSTL, Class III 1.8V | HSTL_III_18 | $V_{REF} - 0.5$ | $V_{REF} + 0.5$ | V_{REF} | 1.1 |
| SSTL (Stub Terminated Transceiver Logic), Class I & II, 3.3V | SSTL3_I, SSTL3_II | $V_{REF} - 0.75$ | $V_{REF} + 0.75$ | V_{REF} | 1.5 |
| SSTL, Class I & II, 2.5V | SSTL2_I, SSTL2_II | $V_{REF} - 0.75$ | $V_{REF} + 0.75$ | V_{REF} | 1.25 |
| SSTL, Class I & II, 1.8V | SSTL18_I, SSTL18_II | $V_{REF} - 0.5$ | $V_{REF} + 0.5$ | V_{REF} | 0.90 |
| SSTL, Class II, 1.5V | SSTL15_II | $V_{REF} - 0.2$ | $V_{REF} + 0.2$ | V_{REF} | 0.75 |
| LVDS (Low-Voltage Differential Signaling), 2.5V & 3.3V | LVDS_25, LVDS_33 | 1.25 – 0.125 | 1.25 + 0.125 | 0 ⁽⁵⁾ | — |
| LVPECL (Low-Voltage Positive Emitter-Coupled Logic), 2.5V & 3.3V | LVPECL_25, LVPECL_33 | 1.2 – 0.3 | 1.2 + 0.3 | 0 ⁽⁵⁾ | — |
| BLVDS (Bus LVDS), 2.5V | BLVDS_25 | 1.3 – 0.125 | 1.3 + 0.125 | 0 ⁽⁵⁾ | — |
| Mini-LVDS, 2.5V & 3.3V | MINI_LVDS_25, MINI_LVDS_33 | 1.2 – 0.125 | 1.2 + 0.125 | 0 ⁽⁵⁾ | — |
| RSDS (Reduced Swing Differential Signaling), 2.5V & 3.3V | RSDS_25, RSDS_33 | 1.2 – 0.1 | 1.2 + 0.1 | 0 ⁽⁵⁾ | — |
| TMDS (Transition Minimized Differential Signaling), 3.3V | TMDS_33 | 3.0 – 0.1 | 3.0 + 0.1 | 0 ⁽⁵⁾ | — |
| PPDS (Point-to-Point Differential Signaling), 2.5V & 3.3V | PPDS_25, PPDS_33 | 1.25 – 0.1 | 1.25 + 0.1 | 0 ⁽⁵⁾ | — |

Notes:

1. Input waveform switches between V_L and V_H .
2. Measurements are made at typical, minimum, and maximum V_{REF} values. Reported delays reflect worst case of these measurements. V_{REF} values listed are typical.
3. Input voltage level from which measurement starts.
4. This is an input voltage reference that bears no relation to the V_{REF} / V_{MEAS} parameters found in IBIS models and/or noted in [Figure 4](#).
5. The value given is the differential input voltage.

Table 34: SSO Limit per V_{CCO}/GND Pair (Cont'd)

| V _{CCO} | I/O Standard | Drive | Slew | SSO Limit per V _{CCO} /GND Pair | | | |
|------------------|--------------|-------|------|--|----------|---|--------------|
| | | | | All TQG144, CPG196, CSG225, FT(G)256, and LX devices in CSG324 | | All CS(G)484, FG(G)484, FG(G)676, FG(G)900, and LXT devices in CSG324 | |
| | | | | Bank 0/2 | Bank 1/3 | Bank 0/2 | Bank 1/3/4/5 |
| Various | LVDS_33 | | | 16 | N/A | 16 | N/A |
| | LVDS_25 | | | 20 | N/A | 20 | N/A |
| | BLVDS_25 | | | 20 | 48 | 20 | 20 |
| | MINI_LVDS_33 | | | 13 | N/A | 13 | N/A |
| | MINI_LVDS_25 | | | 18 | N/A | 18 | N/A |
| | RSDS_33 | | | 12 | N/A | 12 | N/A |
| | RSDS_25 | | | 15 | N/A | 15 | N/A |
| | TMDS_33 | | | 83 | N/A | 83 | N/A |
| | PPDS_33 | | | 12 | N/A | 12 | N/A |
| | PPDS_25 | | | 16 | N/A | 16 | N/A |
| | DISPLAY_PORT | | | 42 | 40 | 42 | 30 |
| | I2C | | | 47 | 55 | 47 | 42 |
| | SMBUS | | | 44 | 52 | 44 | 40 |

Notes:

1. SSO limits greater than the number of I/O per V_{CCO}/GND pair (Table 33) indicate No Limit for the given I/O standard. They are provided in this table to calculate limits when using multiple I/O standards in a bank.
2. Not available (N/A) indicates that the I/O standard is not available in the given bank.
3. When used with the MCB, these signals are exempt from SSO analysis due to the known activity of the MCB switching patterns. SSO performance is validated for all MCB instances. MCB outputs can, in some cases, exceed the SSO limits.

Input Serializer/Deserializer Switching Characteristics

Table 37: ISERDES2 Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|---|---|----------------|----------------|----------------|----------------|-------|
| | | -3 | -3N | -2 | -1L | |
| Setup/Hold for Control Lines | | | | | | |
| T _{ISCKC_BITSLIP} / T _{ISCKC_BITSLIP} | BITSLIP pin Setup/Hold with respect to CLKDIV | 0.16/ -0.09 | 0.20/ -0.09 | 0.31/ -0.09 | 0.34/ -0.14 | ns |
| T _{ISCKC_CE} / T _{ISCKC_CE} | CE pin Setup/Hold with respect to CLK | 0.71/ -0.47 | 0.71/ -0.42 | 0.97/ -0.42 | 1.39/ -0.71 | ns |
| Setup/Hold for Data Lines | | | | | | |
| T _{ISDCK_D} / T _{ISCKD_D} | D pin Setup/Hold with respect to CLK | 0.24/ -0.15 | 0.25/ -0.05 | 0.29/ -0.05 | 0.09/ -0.05 | ns |
| T _{ISDCK_DDLY} / T _{ISCKD_DDLY} | DDLY pin Setup/Hold with respect to CLK (using IODELAY2) | -0.25/ 0.30 | -0.25/ 0.42 | -0.25/ 0.56 | -0.54/ 0.67 | ns |
| T _{ISDCK_D_DDR} / T _{ISCKD_D_DDR} | D pin Setup/Hold with respect to CLK at DDR mode | -0.03/ 0.04 | -0.03/ 0.16 | -0.03/ 0.18 | -0.05/ 0.12 | ns |
| T _{ISDCK_DDLY_DDR} / T _{ISCKD_DDLY_DDR} | D pin Setup/Hold with respect to CLK at DDR mode (using IODELAY2) | -0.40/ 0.48 | -0.40/ 0.53 | -0.40/ 0.71 | -0.71/ 0.86 | ns |
| Sequential Delays | | | | | | |
| T _{ISCKO_Q} | CLKDIV to out at Q pin | 1.30 | 1.44 | 2.02 | 2.22 | ns |
| F _{CLKDIV} | CLKDIV maximum frequency | 270 | 262.5 | 250 | 125 | MHz |

Output Serializer/Deserializer Switching Characteristics

Table 38: OSERDES2 Switching Characteristics

| Symbol | Description | Speed Grade | | | | Units |
|--|---|----------------|----------------|----------------|----------------|-------|
| | | -3 | -3N | -2 | -1L | |
| Setup/Hold | | | | | | |
| T _{OSDCK_D} / T _{OSCKD_D} | D input Setup/Hold with respect to CLKDIV | -0.03/ 1.02 | -0.03/ 1.17 | -0.03/ 1.27 | -0.02/ 0.23 | ns |
| T _{OSDCK_T} / T _{OSCKD_T} ⁽¹⁾ | T input Setup/Hold with respect to CLK | -0.05/ 1.03 | -0.05/ 1.13 | -0.05/ 1.23 | -0.05/ 0.24 | ns |
| T _{OSCCK_OCE} / T _{OSCKC_OCE} | OCE input Setup/Hold with respect to CLK | 0.12/ -0.03 | 0.15/ -0.03 | 0.24/ -0.03 | 0.28/ -0.17 | ns |
| T _{OSCCK_TCE} / T _{OSCKC_TCE} | TCE input Setup/Hold with respect to CLK | 0.14/ -0.08 | 0.17/ -0.08 | 0.27/ -0.08 | 0.31/ -0.16 | ns |
| Sequential Delays | | | | | | |
| T _{OSCKO_OQ} | Clock to out from CLK to OQ | 0.94 | 1.11 | 1.51 | 1.89 | ns |
| T _{OSCKO_TQ} | Clock to out from CLK to TQ | 0.94 | 1.11 | 1.51 | 1.91 | ns |
| F _{CLKDIV} | CLKDIV maximum frequency | 270 | 262.5 | 250 | 125 | MHz |

Notes:

1. T_{OSDCK_T2} / T_{OSCKD_T2} (T input setup/hold with respect to CLKDIV) are reported as T_{OSDCK_T} / T_{OSCKD_T} in TRACE report.

DSP48A1 Switching Characteristics

Table 44: DSP48A1 Switching Characteristics

| Symbol | Description | Pre-adder | Multiplier | Post-adder | Speed Grade | | | | Units |
|--|---|-----------|------------|------------|----------------|----------------|----------------|-----------------|-------|
| | | | | | -3 | -3N | -2 | -1L | |
| Setup and Hold Times of Data/Control Pins to the Input Register Clock | | | | | | | | | |
| T _{DSPDCK_A_A1REG} / T _{DSPCKD_A_A1REG} | A input to A1 register CLK | N/A | N/A | N/A | 0.15/ 0.09 | 0.17/ 0.09 | 0.17/ 0.09 | 0.32/ 0.09 | ns |
| T _{DSPDCK_D_B1REG} / T _{DSPCKD_D_B1REG} | D input to B1 register CLK | Yes | N/A | N/A | 1.90/ -0.07 | 1.95/ -0.07 | 1.95/ -0.07 | 2.82/ -0.07 | ns |
| T _{DSPDCK_C_CREG} / T _{DSPCKD_C_CREG} | C input to C register CLK for XC devices | N/A | N/A | N/A | 0.11/ 0.15 | 0.13/ 0.15 | 0.13/ 0.15 | 0.24/ 0.09 | ns |
| | C input to C register CLK for XA and XQ devices | | | | 0.11/ 0.19 | N/A | 0.13/ 0.23 | 0.24/ 0.09 | |
| T _{DSPDCK_D_DREG} / T _{DSPCKD_D_DREG} | D input to D register CLK for XC devices | N/A | N/A | N/A | 0.09/ 0.15 | 0.10/ 0.15 | 0.10/ 0.15 | 0.19/ 0.12 | ns |
| | D input to D register CLK for XA and XQ devices | | | | 0.09/ 0.23 | N/A | 0.10/ 0.27 | 0.19/ 0.12 | |
| T _{DSPDCK_OPMODE_B1REG} / T _{DSPCKD_OPMODE_B1REG} | OPMODE input to B1 register CLK | Yes | N/A | N/A | 1.97/ 0.01 | 2.00/ 0.01 | 2.00/ 0.01 | 2.85/ 0.01 | ns |
| T _{DSPDCK_OPMODE_OPMODEREG} / T _{DSPCKD_OPMODE_OPMODEREG} | OPMODE input to OPMODE register CLK for XC devices | N/A | N/A | N/A | 0.18/ 0.12 | 0.21/ 0.12 | 0.21/ 0.12 | 0.40/ 0.12 | ns |
| | OPMODE input to OPMODE register CLK for XA and XQ devices | | | | 0.18/ 0.16 | N/A | 0.21/ 0.22 | 0.40/ 0.12 | |
| Setup and Hold Times of Data Pins to the Pipeline Register Clock | | | | | | | | | |
| T _{DSPDCK_A_MREG} / T _{DSPCKD_A_MREG} | A input to M register CLK | N/A | Yes | N/A | 3.06/ -0.40 | 3.51/ -0.40 | 3.51/ -0.40 | 3.97/ -0.40 | ns |
| T _{DSPDCK_B_MREG} / T _{DSPCKD_B_MREG} | B input to M register CLK | Yes | Yes | N/A | 3.96/ -0.68 | 4.58/ -0.68 | 4.58/ -0.68 | 7.00/ -0.68 | ns |
| T _{DSPDCK_D_MREG} / T _{DSPCKD_D_MREG} | D input to M register CLK | Yes | Yes | N/A | 4.23/ -0.56 | 4.80/ -0.56 | 4.80/ -0.56 | 6.84/ -0.56 | ns |
| T _{DSPDCK_OPMODE_MREG} / T _{DSPCKD_OPMODE_MREG} | OPMODE to M register CLK | Yes | Yes | N/A | 4.18/ -0.48 | 4.80/ -0.48 | 4.80/ -0.48 | 6.88/ -0.48 | ns |
| | | No | Yes | N/A | 2.37/ -0.48 | 2.70/ -0.48 | 2.70/ -0.48 | 4.28/ -0.48 | ns |
| Setup and Hold Times of Data/Control Pins to the Output Register Clock | | | | | | | | | |
| T _{DSPDCK_A_PREG} / T _{DSPCKD_A_PREG} | A input to P register CLK | N/A | Yes | Yes | 4.32/ -0.76 | 5.06/ -0.76 | 5.06/ -0.76 | 7.52/ -0.76 | ns |
| T _{DSPDCK_B_PREG} / T _{DSPCKD_B_PREG} | B input to P register CLK | Yes | Yes | Yes | 5.87/ -0.59 | 6.87/ -0.59 | 6.87/ -0.59 | 10.55/ -0.59 | ns |
| | | No | Yes | Yes | 4.14/ -0.93 | 4.68/ -0.93 | 4.68/ -0.93 | 8.12/ -0.93 | ns |
| T _{DSPDCK_C_PREG} / T _{DSPCKD_C_PREG} | C input to P register CLK | N/A | N/A | Yes | 2.20/ -0.23 | 2.25/ -0.23 | 2.25/ -0.23 | 3.27/ -0.23 | ns |
| T _{DSPDCK_D_PREG} / T _{DSPCKD_D_PREG} | D input to P register CLK | Yes | Yes | Yes | 5.90/ -0.92 | 6.91/ -0.92 | 6.91/ -0.92 | 10.39/ -0.92 | ns |

Clock Buffers and Networks

Table 48: Global Clock Switching Characteristics (BUFGMUX)

| Symbol | Description | Devices | Speed Grade | | | | Units |
|--------------------------|-------------------------------|-------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| T_{GSI} | S pin Setup to I0/I1 inputs | LX devices | 0.25 | 0.31 | 0.48 | 0.48 | ns |
| | | LXT devices | 0.25 | 0.31 | 0.48 | N/A | ns |
| T_{GIO} | BUFGMUX delay from I0/I1 to O | LX devices | 0.21 | 0.21 | 0.21 | 0.21 | ns |
| | | LXT devices | 0.21 | 0.21 | 0.21 | N/A | ns |
| Maximum Frequency | | | | | | | |
| F_{MAX} | Global clock tree (BUFGMUX) | LX devices | 400 | 400 | 375 | 250 | MHz |
| | | LXT devices | 400 | 400 | 375 | N/A | MHz |

Table 49: Input/Output Clock Switching Characteristics (BUFIO2)

| Symbol | Description | Devices | Speed Grade | | | | Units |
|--------------------------|--------------------------------|-------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| T_{BUFCKO_O} | Clock to out delay from I to O | LX devices | 0.67 | 0.82 | 1.09 | 1.50 | ns |
| | | LXT devices | 0.67 | 0.82 | 1.09 | N/A | ns |
| Maximum Frequency | | | | | | | |
| F_{MAX} | I/O clock tree (BUFIO2) | LX devices | 540 | 525 | 500 | 300 | MHz |
| | | LXT devices | 540 | 525 | 500 | N/A | MHz |

Table 50: Input/Output Clock Switching Characteristics (BUFIO2FB)

| Symbol | Description | Devices | Speed Grade | | | | Units |
|--------------------------|---------------------------|-------------|-------------|------|-----|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| Maximum Frequency | | | | | | | |
| F_{MAX} | I/O clock tree (BUFIO2FB) | LX devices | 1080 | 1050 | 950 | 500 | MHz |
| | | LXT devices | 1080 | 1050 | 950 | N/A | MHz |

Table 51: Input/Output Clock Switching Characteristics (BUFPLL)

| Symbol | Description | Devices | Speed Grade | | | | Units |
|--------------------------|----------------------------|-------------|-------------|------|-----|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| Maximum Frequency | | | | | | | |
| F_{MAX} | BUFPLL clock tree (BUFPLL) | LX devices | 1080 | 1050 | 950 | 500 | MHz |
| | | LXT devices | 1080 | 1050 | 950 | N/A | MHz |

PLL Switching Characteristics

Table 52: PLL Specification

| Symbol | Description | Device(1) | Speed Grade | | | | Units |
|-------------|---|-------------|-------------|-----|-----|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| F_{INMAX} | Maximum Input Clock Frequency from I/O Clock | LX devices | 540 | 525 | 450 | 300 | MHz |
| | | LXT devices | 540 | 525 | 450 | N/A | MHz |
| | Maximum Input Clock Frequency from Global Clock | LX devices | 400 | 400 | 375 | 250 | MHz |
| | | LXT devices | 400 | 400 | 375 | N/A | MHz |

Table 66: Global Clock Input to Output Delay With PLL in System-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|--|------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| LVCMOS25 Global Clock Input to Output Delay using Output Flip-Flop, 12mA, Fast Slew Rate, <i>with</i> PLL in System-Synchronous Mode. | | | | | | | |
| T _{CLOCKPLL} | Global Clock and OUTFF <i>with</i> PLL | XC6SLX4 | 4.57 | N/A | 6.25 | 7.34 | ns |
| | | XC6SLX9 | 4.57 | 5.25 | 6.25 | 7.34 | ns |
| | | XC6SLX16 | 4.41 | 4.64 | 5.39 | 6.92 | ns |
| | | XC6SLX25 | 4.03 | 4.32 | 4.91 | 7.64 | ns |
| | | XC6SLX25T | 4.03 | 4.32 | 4.91 | N/A | ns |
| | | XC6SLX45 | 4.63 | 4.96 | 5.75 | 7.36 | ns |
| | | XC6SLX45T | 4.63 | 4.96 | 5.75 | N/A | ns |
| | | XC6SLX75 | 4.01 | 4.30 | 4.88 | 7.15 | ns |
| | | XC6SLX75T | 4.01 | 4.30 | 4.88 | N/A | ns |
| | | XC6SLX100 | 4.02 | 4.33 | 4.90 | 7.37 | ns |
| | | XC6SLX100T | 4.06 | 4.33 | 4.90 | N/A | ns |
| | | XC6SLX150 | 3.65 | 3.98 | 4.58 | 6.94 | ns |
| | | XC6SLX150T | 3.65 | 3.98 | 4.58 | N/A | ns |
| | | XA6SLX4 | 4.88 | N/A | 6.13 | N/A | ns |
| | | XA6SLX9 | 4.88 | N/A | 6.13 | N/A | ns |
| | | XA6SLX16 | 4.74 | N/A | 5.27 | N/A | ns |
| | | XA6SLX25 | 4.43 | N/A | 4.78 | N/A | ns |
| | | XA6SLX25T | 4.43 | N/A | 4.88 | N/A | ns |
| | | XA6SLX45 | 4.94 | N/A | 5.62 | N/A | ns |
| | | XA6SLX45T | 4.94 | N/A | 5.62 | N/A | ns |
| | | XA6SLX75 | 4.32 | N/A | 4.77 | N/A | ns |
| | | XA6SLX75T | 4.32 | N/A | 4.77 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 5.41 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 4.77 | 7.15 | ns |
| | | XQ6SLX75T | 4.32 | N/A | 4.77 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 4.60 | 6.94 | ns |
| | | XQ6SLX150T | 4.35 | N/A | 4.60 | N/A | ns |

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. PLL output jitter is included in the timing calculation.

Spartan-6 Device Pin-to-Pin Input Parameter Guidelines

All devices are 100% functionally tested. The representative values for typical pin locations and normal clock loading are listed in [Table 70](#) through [Table 77](#). Values are expressed in nanoseconds unless otherwise noted.

Table 70: Global Clock Setup and Hold Without DCM or PLL (No Delay)

| Symbol | Description | Device | Speed Grade | | | | Units |
|--|---|------------|-------------|------------|------------|------------|-------|
| | | | -3 | -3N | -2 | -1L | |
| Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMS25 Standard.⁽¹⁾ | | | | | | | |
| T_{PSND}/T_{PHND} | No Delay Global Clock and IFF ⁽³⁾ without DCM or PLL | XC6SLX4 | 0.10/1.56 | N/A | 0.10/1.83 | 0.07/2.54 | ns |
| | | XC6SLX9 | 0.10/1.56 | 0.10/1.57 | 0.10/1.84 | 0.07/2.54 | ns |
| | | XC6SLX16 | 0.12/1.42 | 0.12/1.48 | 0.12/1.64 | 0.13/2.19 | ns |
| | | XC6SLX25 | 0.18/1.64 | 0.18/1.75 | 0.18/1.99 | 0.11/2.57 | ns |
| | | XC6SLX25T | 0.18/1.64 | 0.18/1.75 | 0.18/1.99 | N/A | ns |
| | | XC6SLX45 | -0.08/1.80 | -0.08/1.95 | -0.08/2.27 | -0.17/2.74 | ns |
| | | XC6SLX45T | -0.08/1.80 | -0.08/1.95 | -0.08/2.27 | N/A | ns |
| | | XC6SLX75 | 0.13/1.81 | 0.13/2.06 | 0.13/2.27 | -0.12/3.30 | ns |
| | | XC6SLX75T | 0.13/1.81 | 0.13/2.06 | 0.13/2.27 | N/A | ns |
| | | XC6SLX100 | -0.14/2.03 | -0.14/2.24 | -0.14/2.56 | -0.17/3.44 | ns |
| | | XC6SLX100T | -0.14/2.03 | -0.14/2.24 | -0.14/2.56 | N/A | ns |
| | | XC6SLX150 | -0.24/2.42 | -0.24/2.74 | -0.24/2.95 | -0.60/3.75 | ns |
| | | XC6SLX150T | -0.24/2.42 | -0.24/2.74 | -0.24/2.95 | N/A | ns |
| | | XA6SLX4 | 0.10/1.57 | N/A | 0.10/1.84 | N/A | ns |
| | | XA6SLX9 | 0.10/1.57 | N/A | 0.10/1.84 | N/A | ns |
| | | XA6SLX16 | 0.12/1.43 | N/A | 0.12/1.64 | N/A | ns |
| | | XA6SLX25 | 0.18/1.65 | N/A | 0.18/1.99 | N/A | ns |
| | | XA6SLX25T | 0.18/1.65 | N/A | 0.18/1.99 | N/A | ns |
| | | XA6SLX45 | -0.08/1.82 | N/A | -0.08/2.27 | N/A | ns |
| | | XA6SLX45T | -0.08/1.82 | N/A | -0.08/2.27 | N/A | ns |
| | | XA6SLX75 | 0.13/2.02 | N/A | 0.13/2.32 | N/A | ns |
| | | XA6SLX75T | 0.13/2.02 | N/A | 0.13/2.32 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 0.10/2.51 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 0.13/2.32 | -0.12/3.30 | ns |
| | | XQ6SLX75T | 0.13/2.02 | N/A | 0.13/2.32 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | -0.24/2.95 | -0.60/3.75 | ns |
| | | XQ6SLX150T | -0.24/2.74 | N/A | -0.24/2.95 | N/A | ns |

Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage.
2. IFF = Input Flip-Flop or Latch.

Table 72: Global Clock Setup and Hold With DCM in System-Synchronous Mode

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|--|------------|-------------|------------|------------|-----------|-------|
| | | | -3 | -3N | -2 | -1L | |
| Input Setup and Hold Time Relative to Global Clock Input Signal for LVCMOS25 Standard.⁽¹⁾ | | | | | | | |
| T _{PSDCM} / T _{PHDCM} | No Delay Global Clock and IFF ⁽²⁾ with DCM in System-Synchronous Mode | XC6SLX4 | 1.54/0.06 | N/A | 1.75/0.12 | 2.84/0.27 | ns |
| | | XC6SLX9 | 1.54/0.06 | 1.63/0.12 | 1.75/0.12 | 2.84/0.27 | ns |
| | | XC6SLX16 | 1.72/-0.18 | 1.87/-0.17 | 2.13/-0.17 | 2.31/0.26 | ns |
| | | XC6SLX25 | 1.70/-0.03 | 1.78/-0.02 | 2.00/-0.02 | 2.88/0.20 | ns |
| | | XC6SLX25T | 1.70/0.07 | 1.78/0.08 | 2.00/0.08 | N/A | ns |
| | | XC6SLX45 | 1.74/-0.03 | 1.84/-0.02 | 2.02/-0.02 | 2.64/0.52 | ns |
| | | XC6SLX45T | 1.74/-0.01 | 1.84/0.00 | 2.02/0.00 | N/A | ns |
| | | XC6SLX75 | 1.86/0.11 | 1.98/0.12 | 2.20/0.12 | 2.96/0.58 | ns |
| | | XC6SLX75T | 1.86/0.11 | 1.98/0.12 | 2.20/0.12 | N/A | ns |
| | | XC6SLX100 | 1.64/0.07 | 1.72/0.08 | 1.97/0.08 | 2.70/0.99 | ns |
| | | XC6SLX100T | 1.64/0.09 | 1.72/0.10 | 1.97/0.10 | N/A | ns |
| | | XC6SLX150 | 1.53/0.39 | 1.62/0.40 | 1.82/0.40 | 2.75/1.00 | ns |
| | | XC6SLX150T | 1.53/0.39 | 1.62/0.40 | 1.82/0.40 | N/A | ns |
| | | XA6SLX4 | 1.65/0.16 | N/A | 1.75/0.26 | N/A | ns |
| | | XA6SLX9 | 1.65/0.16 | N/A | 1.75/0.26 | N/A | ns |
| | | XA6SLX16 | 1.88/0.02 | N/A | 2.13/0.03 | N/A | ns |
| | | XA6SLX25 | 1.80/0.16 | N/A | 2.05/0.17 | N/A | ns |
| | | XA6SLX25T | 1.80/0.16 | N/A | 2.13/0.17 | N/A | ns |
| | | XA6SLX45 | 1.75/0.12 | N/A | 2.02/0.13 | N/A | ns |
| | | XA6SLX45T | 1.75/0.12 | N/A | 2.02/0.13 | N/A | ns |
| | | XA6SLX75 | 1.87/0.11 | N/A | 2.20/0.12 | N/A | ns |
| | | XA6SLX75T | 1.87/0.11 | N/A | 2.20/0.12 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 2.46/0.24 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 2.20/0.12 | 2.96/0.58 | ns |
| | | XQ6SLX75T | 1.87/0.11 | N/A | 2.20/0.12 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 1.82/0.56 | 2.75/1.00 | ns |
| | | XQ6SLX150T | 1.65/0.55 | N/A | 1.82/0.56 | N/A | ns |

Notes:

1. Setup and Hold times are measured over worst case conditions (process, voltage, temperature). Setup time is measured relative to the Global Clock input signal using the slowest process, highest temperature, and lowest voltage. Hold time is measured relative to the Global Clock input signal using the fastest process, lowest temperature, and highest voltage. These measurements include DCM CLK0 jitter.
2. IFF = Input Flip-Flop or Latch
3. Use IBIS to determine any duty-cycle distortion incurred using various standards.

Table 78: Duty Cycle Distortion and Clock-Tree Skew (Cont'd)

| Symbol | Description | Device ⁽¹⁾ | Speed Grade | | | | Units |
|-----------------|---|-----------------------|-------------|------|------|------|-------|
| | | | -3 | -3N | -2 | -1L | |
| $T_{BUFIOSKEW}$ | I/O clock tree skew across one clock region | LX4 | 0.06 | N/A | 0.06 | 0.07 | ns |
| | | LX9 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX16 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX25 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX25T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX45 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX45T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX75 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX75T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX100 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX100T | 0.06 | 0.06 | 0.06 | N/A | ns |
| | | LX150 | 0.06 | 0.06 | 0.06 | 0.07 | ns |
| | | LX150T | 0.06 | 0.06 | 0.06 | N/A | ns |

Notes:

1. LXT devices are not available with a -1L speed grade. The LX4 is not available in -3N speed grade.
2. These parameters represent the worst-case duty cycle distortion observable at the pins of the device using LVDS output buffers. For cases where other I/O standards are used, IBIS can be used to calculate any additional duty cycle distortion that might be caused by asymmetrical rise/fall times.
3. The T_{CKSKEW} value represents the worst-case clock-tree skew observable between sequential I/O elements. Significantly less clock-tree skew exists for I/O registers that are close to each other and fed by the same or adjacent clock-tree branches. Use the Xilinx FPGA Editor and Timing Analyzer tools to evaluate clock skew specific to your application.
4. The T_{CKSKEW} is 0.43 ns for the XA6SLX100 device using a -2 speed grade and 0.22 ns for the XC6SLX100 devices using the -2 speed grade.

Table 79: Package Skew

| Symbol | Description | Device | Package ⁽²⁾ | Value | Units |
|---------------|-----------------------------|--------|------------------------|-------|-------|
| $T_{PKGSKEW}$ | Package Skew ⁽¹⁾ | LX4 | TQG144 | N/A | ps |
| | | | CPG196 | 23 | ps |
| | | | CSG225 | 58 | ps |
| | | LX9 | TQG144 | N/A | ps |
| | | | CPG196 | 23 | ps |
| | | | CSG225 | 58 | ps |
| | | | FT(G)256 | 88 | ps |
| | | | CSG324 | 64 | ps |
| | | LX16 | CPG196 | 19 | ps |
| | | | CSG225 | 70 | ps |
| | | | FT(G)256 | 71 | ps |
| | | | CSG324 | 54 | ps |
| | | LX25 | FT(G)256 | 90 | ps |
| | | | CSG324 | 61 | ps |
| | | | FG(G)484 | 84 | ps |
| | | LX25T | CSG324 | 48 | ps |
| | | | FG(G)484 | 112 | ps |

Table 79: Package Skew (Cont'd)

| Symbol | Description | Device | Package ⁽²⁾ | Value | Units |
|---------------|-----------------------------|--------|------------------------|-------|-------|
| $T_{PKGSKEW}$ | Package Skew ⁽¹⁾ | LX45 | CSG324 | 70 | ps |
| | | | CS(G)484 | 99 | ps |
| | | | FG(G)484 | 109 | ps |
| | | | FG(G)676 | 138 | ps |
| | | LX45T | CSG324 | 75 | ps |
| | | | CS(G)484 | 100 | ps |
| | | | FG(G)484 | 95 | ps |
| | | LX75 | CS(G)484 | 101 | ps |
| | | | FG(G)484 | 107 | ps |
| | | | FG(G)676 | 161 | ps |
| | | LX75T | CS(G)484 | 107 | ps |
| | | | FG(G)484 | 110 | ps |
| | | | FG(G)676 | 134 | ps |
| | | LX100 | CS(G)484 | 95 | ps |
| | | | FG(G)484 | 155 | ps |
| | | | FG(G)676 | 144 | ps |
| | | LX100T | CS(G)484 | 88 | ps |
| | | | FG(G)484 | 111 | ps |
| | | | FG(G)676 | 147 | ps |
| | | | FG(G)900 | 134 | ps |
| | | LX150 | CS(G)484 | 84 | ps |
| | | | FG(G)484 | 103 | ps |
| | | | FG(G)676 | 115 | ps |
| | | | FG(G)900 | 121 | ps |
| | | LX150T | CS(G)484 | 83 | ps |
| | | | FG(G)484 | 88 | ps |
| | | | FG(G)676 | 141 | ps |
| | | | FG(G)900 | 120 | ps |

Notes:

- These values represent the worst-case skew between any two SelectIO resources in the package: shortest delay to longest delay from Pad to Ball.
- Some of the devices are available in both Pb and Pb-free (additional G) packages as standard ordering options. See [DS160: Spartan-6 Family Overview](#) for more information.

Table 80: Sample Window

| Symbol | Description | Device ⁽¹⁾ | Speed Grade | | | | Units |
|--------------------|---|-----------------------|-------------|-----|-----|-----|-------|
| | | | -3 | -3N | -2 | -1L | |
| T_{SAMP} | Sampling Error at Receiver Pins ⁽²⁾ | All | 510 | 510 | 530 | 740 | ps |
| T_{SAMP_BUFI02} | Sampling Error at Receiver Pins using BUFI02 ⁽³⁾ | All | 430 | 430 | 450 | 590 | ps |

Notes:

- LXT devices are not available with a -1L speed grade.
- This parameter indicates the total sampling error of Spartan-6 FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
 - CLK0 DCM jitter
 - DCM accuracy (phase offset)
 - DCM phase shift resolution
 These measurements do not include package or clock tree skew.
- This parameter indicates the total sampling error of Spartan-6 FPGA DDR input registers, measured across voltage, temperature, and process. The characterization methodology uses the BUFI02 clock network and IODELAY2 to capture the DDR input registers' edges of operation. These measurements do not include package or clock tree skew.

Table 81: Source-Synchronous Pin-to-Pin Setup/Hold and Clock-to-Out Using BUFI02

| Symbol | Description | Device | Speed Grade | | | | Units |
|---|-----------------------------------|------------|-------------|-----------|-----------|------------|-------|
| | | | -3 | -3N | -2 | -1L | |
| Data Input Setup and Hold Times Relative to a Forwarded Clock Input Pin Using BUFI02 | | | | | | | |
| T _{PSCS} /T _{PHCS} | IFF setup/hold using BUFI02 clock | XC6SLX4 | 0.57/0.94 | N/A | 0.95/1.12 | 0.27/1.56 | ns |
| | | XC6SLX9 | 0.40/0.95 | 0.50/0.96 | 0.60/1.12 | 0.27/1.56 | ns |
| | | XC6SLX16 | 0.48/0.74 | 0.55/0.75 | 0.69/0.83 | 1.27/1.31 | ns |
| | | XC6SLX25 | 0.28/1.02 | 0.28/1.12 | 0.28/1.24 | 0.15/1.78 | ns |
| | | XC6SLX25T | 0.28/1.02 | 0.28/1.12 | 0.28/1.24 | N/A | ns |
| | | XC6SLX45 | 0.42/1.19 | 0.44/1.29 | 0.50/1.40 | 0.12/1.83 | ns |
| | | XC6SLX45T | 0.42/1.19 | 0.44/1.29 | 0.50/1.40 | N/A | ns |
| | | XC6SLX75 | 0.38/1.48 | 0.38/1.63 | 0.38/1.84 | 0.05/2.78 | ns |
| | | XC6SLX75T | 0.38/1.48 | 0.38/1.63 | 0.38/1.84 | N/A | ns |
| | | XC6SLX100 | 0.06/1.48 | 0.06/1.63 | 0.06/1.87 | -0.03/2.72 | ns |
| | | XC6SLX100T | 0.06/1.48 | 0.06/1.63 | 0.06/1.87 | N/A | ns |
| | | XC6SLX150 | 0.04/1.73 | 0.04/1.75 | 0.04/1.98 | -0.08/3.07 | ns |
| | | XC6SLX150T | 0.04/1.73 | 0.04/1.75 | 0.04/1.98 | N/A | ns |
| | | XA6SLX4 | 0.64/0.96 | N/A | 0.97/1.12 | N/A | ns |
| | | XA6SLX9 | 0.44/0.99 | N/A | 0.62/1.16 | N/A | ns |
| | | XA6SLX16 | 0.50/0.78 | N/A | 0.69/0.83 | N/A | ns |
| | | XA6SLX25 | 0.28/1.04 | N/A | 0.28/1.25 | N/A | ns |
| | | XA6SLX25T | 0.28/1.04 | N/A | 0.28/1.25 | N/A | ns |
| | | XA6SLX45 | 0.43/1.21 | N/A | 0.50/1.40 | N/A | ns |
| | | XA6SLX45T | 0.43/1.21 | N/A | 0.50/1.40 | N/A | ns |
| | | XA6SLX75 | 0.38/1.49 | N/A | 0.38/1.84 | N/A | ns |
| | | XA6SLX75T | 0.38/1.49 | N/A | 0.38/1.84 | N/A | ns |
| | | XA6SLX100 | N/A | N/A | 1.01/1.63 | N/A | ns |
| | | XQ6SLX75 | N/A | N/A | 0.38/1.84 | 0.05/2.78 | ns |
| | | XQ6SLX75T | 0.38/1.49 | N/A | 0.38/1.84 | N/A | ns |
| | | XQ6SLX150 | N/A | N/A | 0.04/1.98 | -0.08/3.07 | ns |
| | | XQ6SLX150T | 0.04/1.75 | N/A | 0.04/1.98 | N/A | ns |

| Date | Version | Description of Revisions |
|----------|---------|--|
| 06/14/10 | 1.5 | <p>In Table 2, added note 5 and added temperature range to V_{FS} and R_{FUSE}. Removed speed grade delineation, revised I_{RPD} description, and updated note 2 in Table 4. Added note 2 to Table 7. Added DIFF_MOBILE_DDR to Table 8 and Table 10. Added note 4 to Table 15. Changed minimum DV_{PPIN} in Table 16. Updated $F_{GTPDRPCLK}$ in Table 19. Increased maximum T_{LLSKEW} in Table 22. Updated descriptions and added data to Table 23. Removed note 1 and added new data to the Networking Applications section in Table 25. Updated Table 26 and Table 27 to the data in ISE v12.1 software with speed specification v1.08. In Table 28, added DIFF_MOBILE_DDR and updated -4 speed grade data. Updated the maximum I/O pairs per bank in Table 33. Updated note 2 on Table 39. Revised the F_{MAX} in Table 44. In Table 47, updated description for $T_{SMCKCSO}$, revised values for T_{POR} and added Min value, added T_{BPICCK} and $T_{SPIICCK}$. Also in Table 47, added device dependencies to F_{SMCCK} and F_{RBCCCK}. Updated and added data to Table 63 through Table 78, and Table 81. In Table 79, added data on the XC6SLX45-FG(G)676 and revised the XC6SLX45T and XC6SLX150T values.</p> <p>The following changes to this specification are addressed in the product change notice XCN10024, <i>MCB Performance and JTAG Revision Code for Spartan-6 LX16 and LX45 FPGAs</i>.</p> <p>In Table 2, revised the V_{CCINT} to add the memory controller block extended performance specifications. In Table 25, changed the standard specifications and added extended performance specifications for the memory controller block and note 2. Added note 4 and updated values in Table 34.</p> |
| 06/24/10 | 1.6 | <p>Production release of XC6SLX45T (-2 and -3 speed grades), XC6SLX16 and XC6SLX45 (-3 speed grade) devices which includes changes to Table 26 and Table 27 (ISE v12.1 software with speed specification v1.08).</p> <p>Added the -3N speed grade, which designates Spartan-6 devices that do not support MCB functionality. This includes changes to Table 2 (note 2), Table 25 (note 4), and Switching Characteristics (Table 26).</p> <p>Updated Simultaneously Switching Outputs discussion. Added -3 speed grade values for T_{TAP} and F_{MINCAL} values in Table 39. In Table 40, updated T_{RPW} (-2 and -3 speed grade) values and F_{TOG} (-3 speed grade) values. In Table 48, updated T_{GIO} (-2 and -3 speed grade) values. Updated -3 values in spread spectrum section of Table 57.</p> |
| 07/16/10 | 1.7 | <p>Production release of specific devices listed in Table 26 and Table 27 using ISE v12.2 software with speed specification v1.11. Added note 4 advising designers of the patch which contains v1.11. Also updated the -1L speed specification to v1.04. Updated numerous -4 and -1L values. Added -4 T_{TAP} values and F_{MINCAL} to Table 39. Revised T_{CINCK}/T_{CKCIN} in Table 40. In Table 41, revised T_{SHCKO}. In Table 42, revised T_{REG}. Added new -1L values to Table 47. Added and updated values in Table 79.</p> |
| 07/26/10 | 1.8 | <p>Production release of XC6SLX25, XC6SLX25T, XC6SLX100 and XC6SLX100T in the specific speed grades listed in Table 26 and Table 27 using ISE v12.2 software with speed specification v1.11. Added note 7 to Table 2 and moved V_{FS} and R_{FUSE} to a new Table 3. Added I_{HS} and note 4 to Table 4. Added note 1 to Table 28. Added and updated SSO limits per V_{CCO}/GND pairs in Table 34. Added note 3 to Table 47. In Table 54, removed -1L specifications for CLKOUT_PER_JITT_DV1/2 and revised CLKIN_CLKFB_PHASE and CLKOUT_PHASE_DLL values. Updated note 3 in both Table 56 and Table 57.</p> |
| 08/23/10 | 1.9 | <p>Updated values for $F_{GTPRANGE1}$, $F_{GTPRANGE2}$, and $F_{GPLLMIN}$ in Table 18. Revised -3 and -4 values in Table 21. Removed the -1L speed grade readback support restriction and note 3 in Table 47.</p> |
| 11/05/10 | 1.10 | <p>Production release of XC6SLX4 and XC6SLX9 in the specific speed grades listed in Table 26 and Table 27 using ISE v12.3 software with speed specification v1.12 for the -2 speed grade available in the 12.3 Speed Files Patch. Added note 3 advising designers of the patch which contains v1.12.</p> <p>In Table 2, added note 4. In Table 4, added note 2. In Table 10, added notes 2 and 3. In Table 44, added note 2. In Table 47, updated symbol for T_{SMWCCK}/T_{SMCCCK}, changed -1L values for $T_{USERCCLKH}$ and $T_{USERCCLKL}$, and added and revised the modes for F_{MCCK} and F_{SMCCK}. In Table 53, redefined and expanded description for CLKIN_FREQ_DLL and rewrote note 3. Updated title of Table 58. Also in Table 78, revised T_{DCD_CLK} for XC6SLX150 and XC6SLX150T. Changed description of T_{PSFD}/T_{PHFD} in Table 71.</p> <p>For the -1L speed grade, updated data sheet to ISE 12.3 software with speed specification v1.05 which revised the values in the following tables: Table 25, Table 28, Table 35, Table 36, Table 37, Table 40 through Table 43, Table 48 through Table 56, Table 62 through Table 78, Table 80, and Table 81.</p> <p>Updated Notice of Disclaimer.</p> |